

1/3W, 0805, Low Resistance Chip Resistor (Lead / Halogen Free)

1. Scope

This specification applies to 2.0mm x 1.25mm size 1/3W, fixed thick film low resistance value chip resistors rectangular type.

2. Type Designation

RLT1220 - <u>F</u> - <u>□</u> □ □ □ □

(1) (2) (3) (4)

Where (1) Size No.

(2) Power Rating:

F = 1/3W

(3) Resistance value: Refer to paragraph 4-1

For example --

Four digits of number

 $R100 = 0.1\Omega$

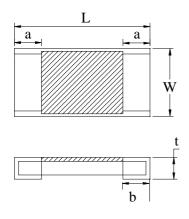
$$1R00 = 1.0\Omega$$

The "R" shall be used as a decimal point

(4) Resistance tolerance:

 $F=\pm1.0\%,\,G=\pm2\%,\,J=\pm5\%$

3. Outline Dimensions



Code Letter	Dimension
L	2.00 ± 0.20
W	1.25 ± 0.20
t	0.50 ± 0.10
a	0.40 ± 0.20
b	0.40 ± 0.20
	TT •/

Unit : mm



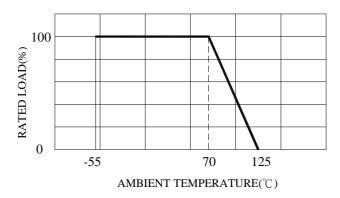
4. Ratings

4-1 Specification

Table 1		
Power Rating*	1/3 V	V
Resistance Tolerance	1%(F), 2%(G), 5%(J)	
Resistance Range	0.05~<0.1Ω 0.1~<10Ω	
Temperature Coefficient of Resistance(ppm/°C)	0~+300	0~+200

Note*:

Power Rating is based on continuous full load operation at rated ambient temperature of 70° C. For resistor operated at ambient temperature in excess of 70° C, the maximum load shall be derated in accordance with the following curve.



4-2 Rated Voltage

The d.c. or a.c. r.m.s. voltage shall be calculated from the following expression

 $V = \sqrt{P \times R}$

Where V : Rated voltage (V)

- P : Rated power (W)
- R : Nominal resistance (Ω)
- 4-3 Operating and Storage Temperature Range -55 to +125 $^\circ \! \mathbb{C}$



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5. Marking

Each Resistor is marked with 4 digits code on the protective coating to designate to the nominal resistance value.

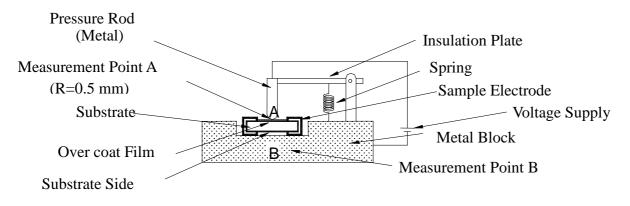
 $0.05 \, \leq \, R \, < \! 10 \Omega$, Marking 4 digits

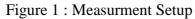
EX)	$0.05\Omega \rightarrow$	R050	,	$0.1\Omega \rightarrow R100$
	$4.7\Omega \rightarrow$	4R70	,	$10\Omega \rightarrow 10R0$

6. Characteristics

6-1 Electrical

Item	Specification and Requirement	Test Method (JIS 5201)
Temperature Coefficient of Resistance(ppm/℃)		Room temperature Room temperature +100°C
Short Time Overload	 △ R:±1.0% Without damage by flashover, spark, arcing, burning or breakdown 	 (1) Applied voltage: 2.5 x rated voltage (2) Test time: 5 seconds
Insulation Resistance	Over 100 M Ω on Overcoat layer face up Over 1,000 M Ω on Substrate side face up	 (1) Setup as figure 1 (2) Test voltage: 100V_{DC}±15V_{DC} (3) Test time: 60 + 10 / - 0 seconds
Voltage Proof	Resistance range:±1.0% Without damage by flashover, spark, arcing, burning or breakdown	 (1) Setup as figure 1 (2) Test voltage: 400V_{AC}(rms.) (3) Test time: 60 + 10 / - 0 seconds







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Item	Specification and Requirement	Test Method (JIS 5201)
Solderability	The surface of terminal immersed shall be minimum of 95% covered with a new coating of solder	Solder bath: After immersing in flux, dip in $245 \pm 5^{\circ}$ C molten solder bath for 2 ± 0.5 seconds
Resistance to Solder Heat	\triangle R: ± 1.0% Without distinct deformation in appearance	 Pre-heat: 100~110°C for 30 seconds Immersed at solder bath of 270 ± 5°C for 10 ± 1 seconds Measuring resistance 1 hour after test
Bending Test	\triangle R: ± 1.0% Without mechanical damage such as break	Bending value: 3 mm for 30 ± 1 seconds
Solvent Resistance	Without mechanical and distinct damage in appearance	 (1) Solvent: Trichloroethane or Isopropyl alcohol (2) Immersed in solvent at room temperature for 300 seconds



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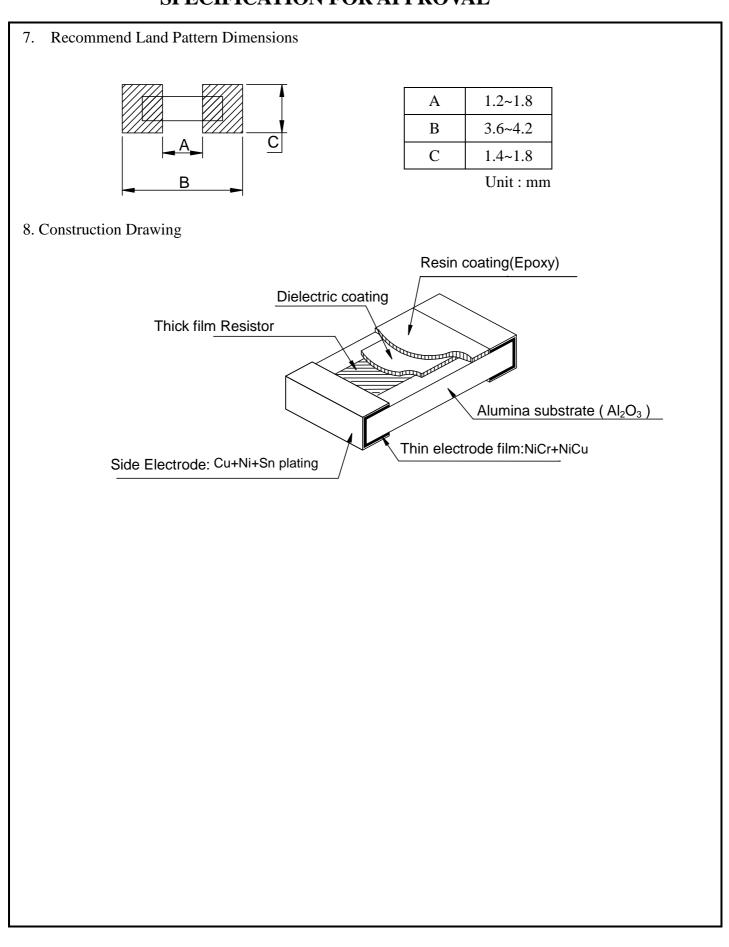
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5-3 Endurance		
Item	Specification and Requirement	Test Method (JIS 5201)
Rapid Change of Temperature		 (1) Repeat 5 cycle as follow: (-55 ± 3°C, 30minutes) →(Room temperature, 2~3 minutes) →(+125 ± 2°C, 30minutes) →(Room temperature 2~3 minutes) (2) Measuring resistance 1 hour after test
Moisture with Load		(1) Environment condition: $40 \pm 2^{\circ}C, 90 \sim 95\%$ RH (2) Applied Voltage: rated voltage (3) Test period: (1.5 hour ON) \rightarrow (0.5 hour OFF) cycled for total 1,000 + 48 / - 0 hours (4) Measuring resistance 1 hour after test
Load Life	 △ R: ±5.0% Without distinct damage in appearance 	 (1) Test temperature: 70 ± 3°C (2) Applied Voltage: rated voltage (3) Test period: (1.5 hour ON) →(0.5 hour OFF) cycled for total 1,000 + 48 / - 0 hours (4) Measuring resistance 1 hour after test
Low Temperature Store	\triangle R: ± 5.0% Without distinct damage in appearance	 (1) Store temperature: -55 ± 3°C for total 1,000 + 48 / - 0 hours (2) Measuring resistance 1 hour after test
High Temperature Store	\triangle R: ± 5.0% Without distinct damage in appearance	(1) Store temperature: +125 \pm 2°C for total 1,000 + 48 / - 0 hours (2) Measuring resistance 1 hour after test

SPECIFICATION FOR APPROVAL

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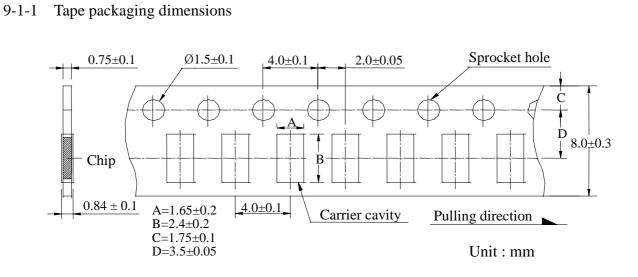
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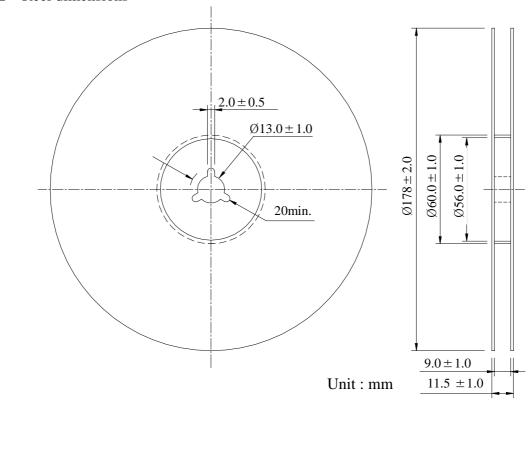


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- 9. Packaging
 - 9-1 Dimensions



- Remark: Leader tape length \geq 30 cm(150 Hollow carrier cavity)
- 9-1-2 Reel dimensions



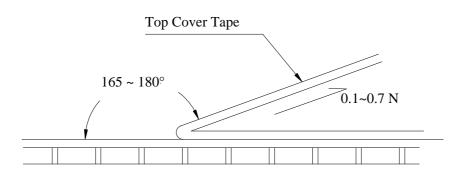
SPECIFICATION FOR APPROVAL

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9-2 Peel force of top cover tape

The peel speed shall be about 300 mm/min.

The peel force of top cover tape shall be between 0.1 to 0.7 N.



9-3 Numbers of taping 5,000 pieces /reel

9-4 Label making

The following items shall be marked on the reel.

- (1) Type designation.
- (2) Quantity
- (3) Manufacturing date code
- (4) Manufacturer's name



10. Carenote

- 10-1 Care note for storage
 - (1) Chip resistor shall be stored in a room where temperature and humidity must be controlled. (temperature 5 to 35°C, humidity 45 to 85% RH) However, a humidity keep it low, as it is possible.
 - (2) Chip resistor shall be stored as direct sunshine doesn't hit on it.
 - (3) Chip resistor shall be stored with no moisture, dust, a material that will make solderability inferior, and a harmful gas (Chloridation hydrogen, sulfurous acid gas, and sulfuration hydrogen)
- 10-2 Carenote for operating and handling
 - (1) It is necessary to protect the edge and protection coat of resistors from mechanical stress.
 - (2) Handle with care when printing circuit board (PCB) is divided or fixed on support body, because bending of printing circuit board (PCB) mounting will make mechanical stress for resistors.
 - (3) Resistors shall be used with in rated range shown in specification. Especially, if voltage more than specified value will be loaded to resistor, there is a case it will make damage for machine because of temperature rise depending on generating of heat, and increase resistance value or breaks.
 - (4) In case that resistor is loaded a rated voltage, it is necessary to confirms temperature of a resistor and to reduce a load power according to load reduction curve, because a temperature rise of a resistor depends on influence of heat from mounting density and neighboring element.
 - (5) Observe Limiting element voltage and maximum overload voltage specified in each specification
 - (6) If there is possibility that a large voltage (pulse voltage, shock voltage) charge to resistor, it is necessary that operating condition shall be set up before use.